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NXP Semiconductors/Freescale Semiconductor, Inc. EC103D1,116

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Distributor of NXP Semiconductors/Freescale Semiconductor, Inc. : Excellent Integrated Datasheet of EC103D1,116 - THYRISTOR GATE 400V 0.8A TO92 Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



Product data sheet

1. General description

Planar passivated ultra sensitive gate Silicon Controlled Rectifier in a SOT54 (T0-92) plastic package.

2. Features and benefits

- Planar passivated for voltage ruggedness and reliability
- Ultra sensitive gate

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22 July 2014

3. Applications

- Electronic ballasts
- Safety shut down and protection circuits
- Sensing circuits
- Smoke detectors
- Switched Mode Power Supplies

4. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DRM}	repetitive peak off- state voltage		-	-	400	V
V _{RRM}	repetitive peak reverse voltage		-	-	400	V
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)} = 25 \text{ °C};$ $t_p = 10 \text{ ms}; \text{ Fig. 4}; \text{ Fig. 5}$	-	-	8	A
I _{T(AV)}	average on-state current	half sine wave; T _{lead} ≤ 92 °C; <u>Fig. 1</u>	-	-	0.5	A
I _{T(RMS)}	RMS on-state current	half sine wave; T _{lead} ≤ 92 °C; <u>Fig. 2;</u> <u>Fig. 3</u>	-	-	0.8	A
Static chara	acteristics	· · · · · ·	, I			
I _{GT}	gate trigger current	V _D = 12 V; I _T = 10 mA; T _j = 25 °C; Fig. 7	-	3	12	μA







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5. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	к	cathode		А- ДГ К
2	G	gate		G sym037
3	A	anode		
			321	
			TO-92 (SOT54)	

6. Ordering information

Table 3.Ordering information

Type number			
	Name	Description	Version
EC103D1	TO-92	plastic single-ended leaded (through hole) package; 3 leads	SOT54



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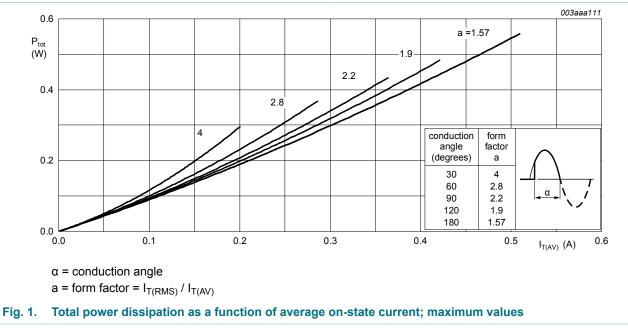
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Limiting values 7.

Table 4. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage		-	400	V
V _{RRM}	repetitive peak reverse voltage		-	400	V
I _{T(AV)}	average on-state current	half sine wave; T _{lead} ≤ 92 °C; <u>Fig. 1</u>	-	0.5	А
I _{T(RMS)}	RMS on-state current	half sine wave; T _{lead} ≤ 92 °C; <u>Fig. 2;</u> <u>Fig. 3</u>	-	0.8	A
I _{TSM}	non-repetitive peak on-state current	half sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 10 \text{ ms}$; <u>Fig. 4</u> ; <u>Fig. 5</u>	-	8	A
		half sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 8.3 \text{ ms}$	-	9	A
l ² t	I ² t for fusing	t _p = 10 ms; SIN	-	0.32	A ² s
dI _T /dt	rate of rise of on-state current	I_T = 2 A; I_G = 10 mA; dI_G/dt = 100 mA/ µs	-	50	A/µs
I _{GM}	peak gate current		-	1	А
V _{RGM}	peak reverse gate voltage		-	5	V
P _{GM}	peak gate power		-	2	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.1	W
T _{stg}	storage temperature		-40	150	°C
Tj	junction temperature		-	125	°C



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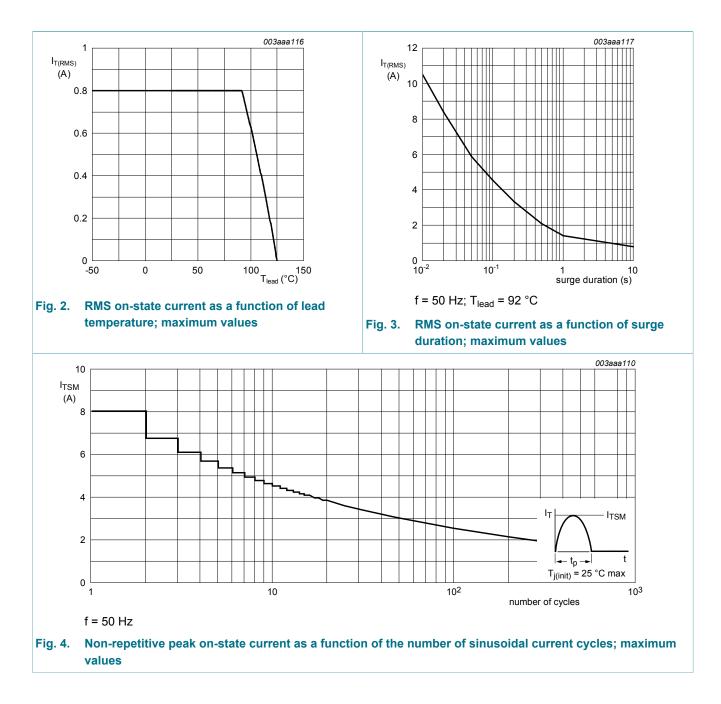


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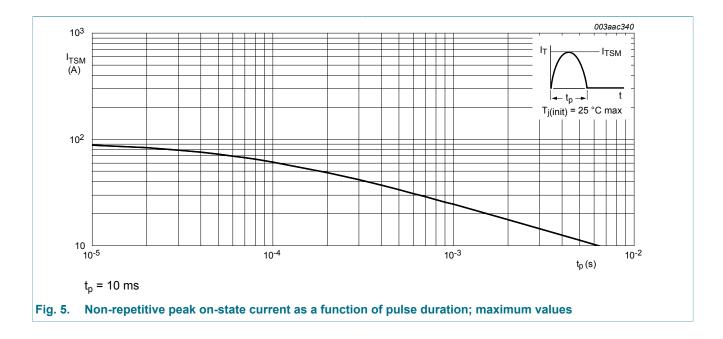


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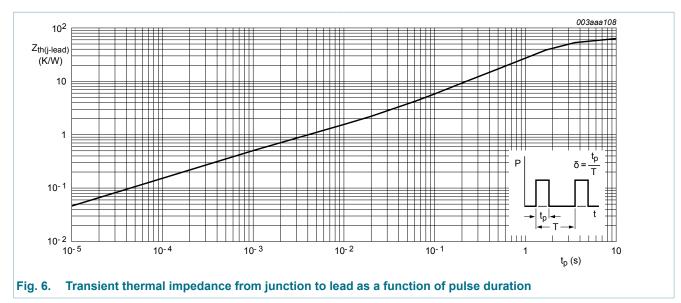


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8. Thermal characteristics

Table 5. The	rmal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
R _{th(j-lead)}	thermal resistance from junction to lead	<u>Fig. 6</u>	-	-	60	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	printed circuit board mounted: lead length = 4 mm	-	150	-	K/W





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9. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static char	acteristics	· · · · · · · · · · · · · · · · · · ·	, i			
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; I_T = 10 \text{ mA}; T_j = 25 \text{ °C};$ Fig. 7	-	3	12	μA
IL	latching current	V_D = 12 V; I _G = 0.5 mA; R _{GK} = 1 kΩ; T _j = 25 °C; Fig. 8	-	2	6	mA
I _H	holding current	V_D = 12 V; R_{GK} = 1 k Ω ; T_j = 25 °C; Fig. 9	-	2	5	mA
V _T	on-state voltage	I _T = 1 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.2	1.35	V
V _{GT}	gate trigger voltage	V_D = 12 V; I _T = 10 mA; T _j = 25 °C; Fig. 11	-	0.5	0.8	V
		V _D = 400 V; I _T = 10 mA; T _j = 125 °C; Fig. 11	0.2	0.3	-	V
I _D	off-state current	V_D = 400 V; T_j = 125 °C; R_{GK} = 1 k Ω	-	0.05	0.1	mA
I _R	reverse current	V_R = 400 V; T _j = 125 °C; R _{GK} = 1 k Ω	-	0.05	0.1	mA
Dynamic cl	naracteristics	· · · · · ·	I		1	
dV _D /dt	rate of rise of off-state voltage	$V_{DM} = 268 \text{ V}; \text{ T}_{j} = 125 \text{ °C}; \text{ R}_{GK} = 1 \text{ k}\Omega;$ (V _{DM} = 67% of V _{DRM}); exponential waveform; Fig. 12	-	150	-	V/µs
t _{gt}	gate-controlled turn-on time	I_{TM} = 2 A; V _D = 400 V; I _G = 10 mA; dI _G / dt = 0.1 A/µs; T _j = 25 °C	-	2	-	μs
t _q	commutated turn-off time	$\begin{split} V_{DM} &= 268 \text{ V}; \text{T}_{\text{j}} = 125 ^{\circ}\text{C}; \text{I}_{\text{TM}} = 1.6 \text{ A}; \\ V_{\text{R}} &= 35 \text{ V}; (\text{dI}_{\text{T}}/\text{dt})_{\text{M}} = 30 \text{A}/\mu\text{s}; \text{dV}_{\text{D}}/ \\ \text{dt} &= 2 \text{V}/\mu\text{s}; \text{R}_{\text{GK}} = 1 \text{k}\Omega\text{; } (\text{V}_{\text{DM}} = 67\% \text{of} \\ \text{V}_{\text{DRM}}) \end{split}$	-	100	-	μs

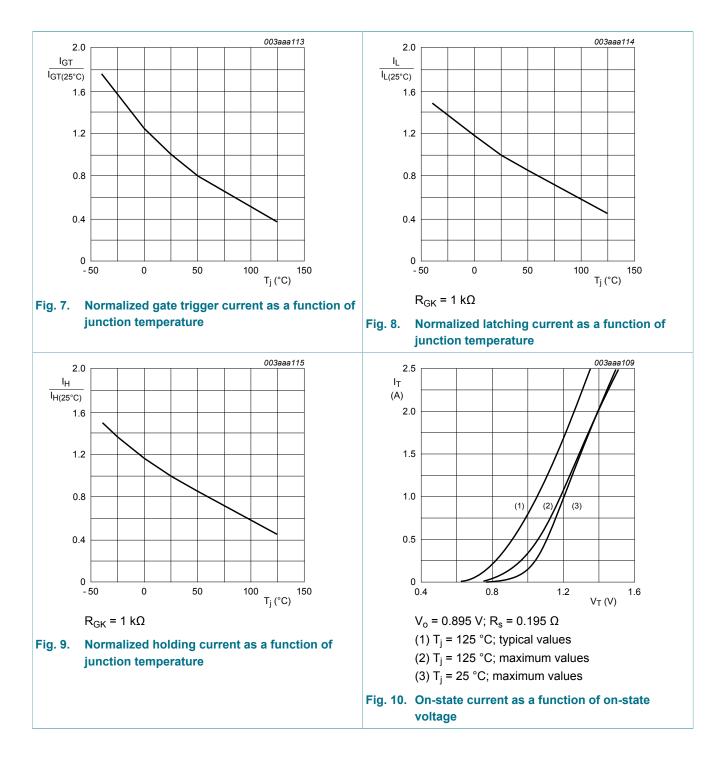


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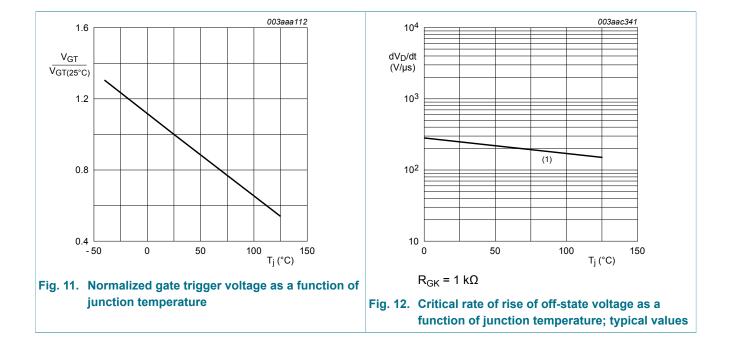


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10. Package outline

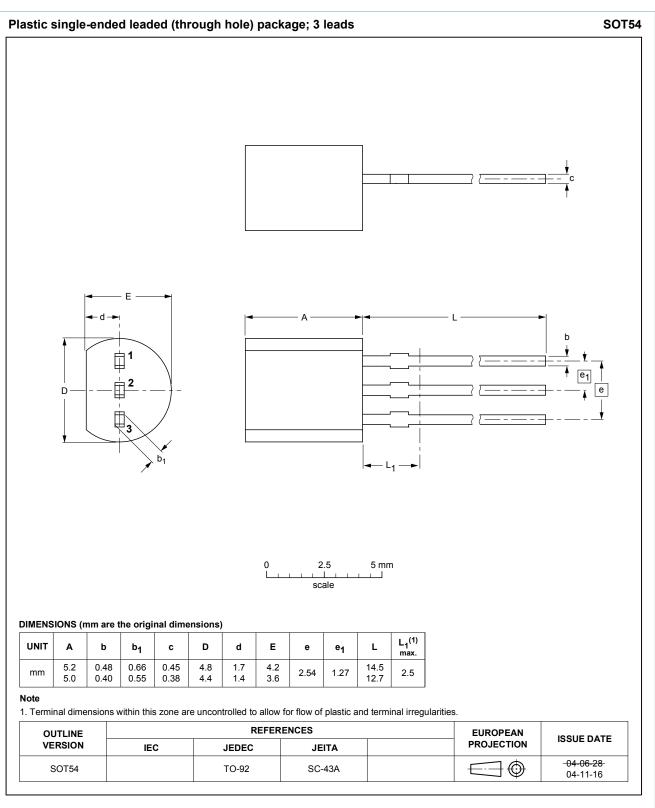


Fig. 13. Package outline TO-92 (SOT54)

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

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